



**International Design Engineering  
Technical Conferences (DETC) and  
Computers and Information in  
Engineering Conference (CIE)**

September 10-13, 2006

Philadelphia, Pennsylvania



<http://detc2006.seas.upenn.edu>

The 2006 ASME International Design Engineering Technical Conferences (DETC) and Computers and Information in Engineering Conference (CIE) will be held on September 10-13, 2006 at the Wyndham Philadelphia at Franklin Plaza, in Philadelphia, Pennsylvania. The conference is the flagship international meeting in design engineering and includes the following conferences and special symposia:

**32nd Design Automation Conference (DAC)**

Conference Chair: Prof. Hae Chang Gea  
Department of Mechanical and Aerospace Engineering  
Rutgers University  
Email: [gea@rci.rutgers.edu](mailto:gea@rci.rutgers.edu)  
URL: [swhite.me.washington.edu/~asmeda/2006DAC/](http://swhite.me.washington.edu/~asmeda/2006DAC/)

**30th Annual Mechanisms and Robotics Conference (MR)**

Conference Chair: Prof. G. R. Pennock  
School of Mechanical Engineering  
Purdue University  
Email: [pennock@ecn.purdue.edu](mailto:pennock@ecn.purdue.edu)  
URL: [www.asme.org/divisions/ded/mechcomm/](http://www.asme.org/divisions/ded/mechcomm/)

**26th Computers and Information in Engineering Conference (CIE)**

Conference Chair: Prof. Imre Horváth  
Department of Design Engineering  
Delft University of Technology  
E-mail: [I.Horvath@IO.TUdelft.nl](mailto:I.Horvath@IO.TUdelft.nl)  
URL: [www.asme.org/divisions/cie/events/cie2006/cie2006cfp.html](http://www.asme.org/divisions/cie/events/cie2006/cie2006cfp.html)

**18th International Conference on Design Theory and Methodology (DTM)**

Conference Chair: Prof. John K. Gershenson  
Department of Mechanical Engineering and Engineering Mechanics  
Michigan Technological University  
E-mail: [jkgershe@mtu.edu](mailto:jkgershe@mtu.edu)  
URL: [function.basiceng.umd.edu/dtm2006/](http://function.basiceng.umd.edu/dtm2006/)

**11th Design for Manufacturing and the Lifecycle Conference (DFM)**

Conference Chair: Prof. Bill Wood  
Department of Mechanical Engineering  
University of Maryland Baltimore County  
Email: [bwood@umbc.edu](mailto:bwood@umbc.edu)  
URL: [www.isr.umd.edu/dfm/2006/](http://www.isr.umd.edu/dfm/2006/)

**3rd Symposium on International Issues in Engineering Design**

Symposium Chair: Prof. Philip E. Doepker  
Department of Mechanical and Aerospace Engineering  
University of Dayton  
Email: [Phil.Doepker@notes.udayton.edu](mailto:Phil.Doepker@notes.udayton.edu)  
URL: [www.engr.udayton.edu/dmclinic](http://www.engr.udayton.edu/dmclinic)

Technical papers and presentations on various topics of engineering design are solicited for the conference. Please refer to the individual call for papers for each conference and contact the respective conference chairs for inquiries about the conference. The conference will include plenary sessions, keynote lectures, and tutorials on topics related to engineering design. Industry participation is particularly welcome; indeed, we hope the conference will provide opportunities for fruitful communication between the research and industrial communities.

The Wyndham is located just four blocks from the heart of Philadelphia's center city. It is just 15 minutes from Philadelphia International Airport and is near all of the city's attractions, including exceptional museums, galleries, the Liberty Bell Pavilion, Independence Hall, world-class entertainment and restaurants.

We welcome you to Philadelphia in September, 2006.

**Vijay Kumar**  
**General Conference Chair**  
**University of Pennsylvania**  
**Email: [detc@seas.upenn.edu](mailto:detc@seas.upenn.edu)**  
**[www.grasp.upenn.edu/~kumar/](http://www.grasp.upenn.edu/~kumar/)**

**Deadlines:**

Submission of Draft Paper: **February 6, 2006**  
Paper Reviews Completed: **April 14, 2006**  
Author Notification: **April 28, 2006**  
Submission of Final Paper: **May 19, 2006**

**IDETC Conferences Organizing Committee:**

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